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<b>AMENDMENT TRANSMITTAL LETTER</b>			Docket No. M4065.0374/P374				
Application No. 09/760,741-Conf. #5786		Filing Date January 17, 2001		Examiner C. C. Chu		Art Unit 2815	
Applicant(s): Mike Brooks							
Invention: SEMICONDUCTOR ASSEMBLY WITHOUT ADHESIVE FILLETS							
<b>TO THE COMMISSIONER FOR PATENTS</b>							
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.							
<b>CLAIMS AS AMENDED</b>							
	Claims Remaining After Amendment	Highest Number Previously Paid		Number Extra Claims Present	Rate		
<b>Total Claims</b>	17	- 39 =			x	0.00	
<b>Independent Claims</b>	4	- 7 =			x	0.00	
<b>Multiple Dependent Claims (check if applicable)</b>							
<b>Other fee (please specify):</b>							
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:</b>						0.00	
<input checked="" type="checkbox"/> Large Entity <span style="margin-left: 200px;"><input type="checkbox"/> Small Entity</span>							
<input checked="" type="checkbox"/> No additional fee is required for this amendment.							
<input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of \$ _____. A duplicate copy of this sheet is enclosed.							
<input type="checkbox"/> A check in the amount of \$ _____ to cover the filing fee is enclosed.							
<input type="checkbox"/> Payment by credit card. Form PTO-2038 is attached.							
<input checked="" type="checkbox"/> The Director is hereby authorized to charge and credit Deposit Account No. <u>04-1073</u> as described below. A duplicate copy of this sheet is enclosed.							
<input checked="" type="checkbox"/> Credit any overpayment.							
<input checked="" type="checkbox"/> Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.							
 _____ Thomas J. D'Amico Attorney Reg. No.: 28,371					Dated: <u>October 26, 2004</u>		
DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP 2101 L Street NW Washington, DC 20037-1526 (202) 828-2232							



Docket No.: M4065.0374/P374  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Mike Brooks

Confirmation No.: 5786

Application No.: 09/760,741

Art Unit: 2815

Filed: January 17, 2001

Examiner: C. C. Chu

For: SEMICONDUCTOR ASSEMBLY WITHOUT  
ADHESIVE FILLETS

**AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated July 26, 2004 (Paper No. Mail Date 20040719), please amend the above-identified U.S. patent application as follows:

**Amendments to the claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 8 of this paper.